### 300 to 930MHz Receiver Evaluation Board Description

#### Features

Programmable PLL synthesizer
8-channel preconfigured or fully programmable SPI mode
Double super-heterodyne receiver architecture with 2 <sup>nd</sup> mixer as image rejection mixer
Reception of FSK, FM and ASK modulated signals
Low shut-down and operating currents
Build-in acceptance of input frequency variations
On-chip IF filter
Fully integrated FSK/FM demodulator
RSSI for level indication and ASK detection
2 <sup>nd</sup> order low-pass data filter
Positive and negative peak detectors
Data slicer (with averaging or peak-detector adaptive threshold)
EVB programming software is available on Melexis web site

#### **Ordering Information**

Part No. (see paragraph 6)

EVB71122C-315-C EVB71122C-433-C

Note: SPI mode is default population, ABC mode according to paragraph 4.2

### Application Examples

- ☐ General digital and analog RF receivers at 300 to 930MHz
- ☐ Tire pressure monitoring systems (TPMS)
- ☐ Remote keyless entry (RKE)
- □ Low power telemetry systems
- □ Alarm and security systems
- ☐ Active RFID tags
- □ Remote controls
- □ Garage door openers
- ☐ Home and building automation

#### Evaluation Board Example



EVB71122C-868-C

EVB71122C-915-C

### General Description

The MLX71122 is a multi-channel RF receiver IC based on a double-conversion super-heterodyne architecture. It is designed to receive FSK and ASK modulated RF signals either in 8 predefined frequency channels or frequency programmable via a 3-wire serial programming interface (SPI).

The IC is designed for a variety of applications, for example in the European bands at 433MHz and 868MHz or for the use in North America or Asia, e.g. at 315MHz, 447MHz or 915MHz.



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### 300 to 930MHz Receiver Evaluation Board Description

### 1 Theory of Operation

#### 1.1 General

The MLX71122 receiver architecture is based on a double-conversion super-heterodyne approach. The two LO signals are derived from an on-chip integer-N PLL frequency synthesizer. The PLL reference frequency is derived from a crystal (XTAL). The PLL synthesizer consists of an integrated voltage-controlled oscillator with external inductor, a programmable feedback divider chain, a programmable reference divider, a phase-frequency detector with a charge pump and an external loop filter.

In the receiver's down-conversion chain, two mixers MIX1 and MIX2 are driven by the internal local oscillator signals LO1 and LO2, respectively. The second mixer MIX2 is an image-reject mixer. As the first intermediate frequency (IF1) is very high (typically above 100 MHz), a reasonably high degree of image rejection is provided even without using an RF front-end filter. At applications asking for very high image rejections, cost-efficient RF front-end filtering can be realized by using a SAW filter in front of the LNA.

The receiver signal chain is setup by a low noise amplifier (LNA), two down-conversion mixers (MIX1 and MIX2), an on-chip IF filter (IFF) as well as an IF amplifier (IFA). By choosing the required modulation via an FSK/ASK switch (at pin MODSEL), either the on-chip FSK demodulator (FSK DEMOD) or the RSSI-based ASK detector is selected. A second order data filter (OA1) and a data slicer (OA2) follow the demodulator. The data slicer threshold can be generated from the mean-value of the data stream or by means of the positive and negative peak detectors (PKDET+/-).

In general the MLX71122 can be set to shut-down mode, where all receiver functions are completely turned off, and to several other operating modes. There are two global operating modes that are selectable via the logic level at pin SPISEL:

- 8-channel preconfigured mode (ABC mode)
- fully programmable mode (SPI mode).

In ABC mode the number of frequency channels is limited to eight but no microcontroller programming is required. In this case the three lines of the serial programming interface (SPI) are used to select one of the eight predefined frequency channels via simple 3-bit parallel programming. Pins ENRX and MODSEL are used to enable/disable the receiver and to select FSK or ASK demodulation, respectively.

SPI mode is recommended for full programming flexibility. In this case the three lines of the SPI are configured as a standard 3-wire bus (SDEN, SDTA and SCLK). This allows changing many parameters of the receiver, for example more operating modes, channels, frequency resolutions, gains, demodulation types, data slicer settings and more. The pin MODSEL has no effect in this mode.

#### 1.2 EVB Data Overview

Input frequency ranges: 300 to 930MHz	Total image rejection: > 65dB (with external
Power supply range: 3.0 to 5.5V	RF front-end filter)
Temperature range: -40 to +105°C	FSK/FM deviation range: ±10 to ±50kHz
Shutdown current: 50nA	Spurious emission: < -70dBm
Operating current: 11mA (typ.)	Linear RSSI range: > 70dB
Internal IF2: 2MHz with 230kHz 3dB bandwidth	FSK input frequency acceptance range:
Maximum data rate: 100kbps NRZ code,	170kHz (3dB)
50kbps bi-phase code	Crystal reference frequency: 10MHz
Minimum frequency resolution: 10kHz	•

☐ Input Sensitivity: at 4 kbps NRZ, BER = 3·10 <sup>-3</sup>								
Frequency 315 MHZ 433 MHz 868 MHz 915 MHz								
FSK: ±20 kHz deviation	-106dBm	-104dBm	-101dBm	-101dBm				
ASK	-108dBm	-108dBm	-106dBm	-106dBm				

#### 1.3 Block Diagram

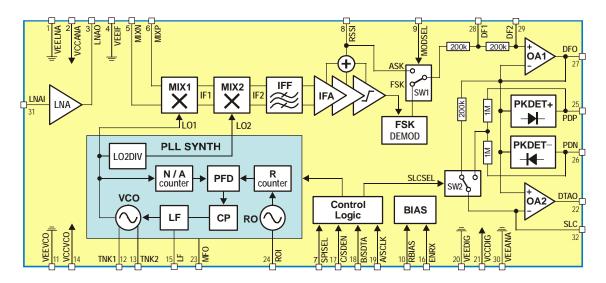


Fig. 1: MLX71122 block diagram

The MLX71122 receiver IC consists of the following building blocks:

- PLL synthesizer (PLL SYNTH) to generate the first and second local oscillator signals LO1 and LO2, parts of the PLL SYNTH are the voltage-controlled oscillator (VCO), the feedback dividers N/A and R, the phase-frequency detector (PFD), the charge pump (CP) and the crystal-based reference oscillator (RO)
- Low-noise amplifier (LNA) for high-sensitivity RF signal reception
- First mixer (MIX1) for down-conversion of the RF signal to the first IF (intermediate frequency)
- Second mixer (MIX2) with image rejection for down-conversion from the first to the second IF
- IF Filter (IFF) with a 2MHz center frequency and a 230kHz 3dB bandwidth
- IF amplifier (IFA) to provide a large amount of voltage gain and an RSSI signal output
- FSK demodulator (FSK DEMOD)
- Operational amplifiers OA1 and OA2 for low-pass filtering and data slicing, respectively
- Positive (PKDET+) and negative (PKDET-) peak detectors
- Switches SW1 to select between FSK and ASK as well as SW2 to chose between averaging or peak detector data slicer
- Control logic with 3-wire bus serial programming interface (SPI)
- · Biasing circuit with modes control

For more detailed information, please refer to the latest MLX71122 data sheet revision.

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#### 1.4 Enable/Disable in ABC Mode

ENRX	Description
0	Shutdown mode
1	Receive mode

Pin ENRX is pulled down internally. Device is in shutdown by default, after power supply on. If ENRX = 0 and SPISEL = 1 then operating modes according to OPMODE bit (refer to control word R0). If ENRX = 1 then OPMODE bit has no effect (hardwired receive mode).

#### 1.5 Demodulation Selection in ABC Mode

MODSEL	Description
0	FSK demodulation
1	ASK demodulation

Pin MODSEL has no effect in SPI mode (SPISEL = 1). We recommend connecting it to ground to avoid a floating CMOS gate.

#### 1.6 Programming Modes

SPISEL	Description
0	ABC mode (8 channels preconfigured)
1	SPI mode (programming via 3-wire bus)

#### 1.7 Preconfigured Frequencies in ABC Mode

Α	В	С	Receive Frequency
0	0	0	FSK1: 369.5 MHz
0	1	0	FSK5: 388.3 MHz
1	0	0	FSK2: 371.1 MHz
1	1	0	FSK4: 376.9 MHz
0	0	1	FSK3: 375.3 MHz
0	1	1	FSK7: 394.3 MHz
1	0	1	FSK6: 391.5 MHz
1	1	1	FSK8: 395.9 MHz

As all pins, pins A, B, and C are equipped with ESD protection diodes that are tied to VCC and to VEE. Therefore these pins should not be directly connected to positive supply (a logic "1") before the supply voltage is applied to the IC. Otherwise the IC will be supplied through these control lines and it may enter into an unpredictable mode. In case the user wants to apply a positive supply voltage to these pins before the supply voltage is applied to the IC, a protection resistor should be inserted in each control line.

#### 2 Functional Description

#### 2.1 Frequency Planning

Because of the double conversion architecture that employs two mixers and two IF signals, there are four different combinations for injecting the LO1 and LO2 signals:

LO1 high side and LO2 high side: receiving at f<sub>RF</sub>(high-high)
 LO1 high side and LO2 low side: receiving at f<sub>RF</sub>(high-low)
 LO1 low side and LO2 high side: receiving at f<sub>RF</sub>(low-high)
 LO1 low side and LO2 low side: receiving at f<sub>RF</sub>(low-low)

As a result, four different radio frequencies (RFs) could yield one and the same second IF (IF2). Fig. 2 shows this for the case of receiving at  $f_{RF}$ (high-high). In the example of Fig. 2, the image signals at  $f_{RF}$ (low-high) and  $f_{RF}$ (low-low) are suppressed by the bandpass characteristic provided by the RF front-end. The bandpass shape can be achieved either with a SAW filter (featuring just a couple of MHz bandwidth), or by the tank circuits at the LNA input and output (this typically yields 30 to 60MHz bandwidth). In any case, the high value of the first IF (IF1) helps to suppress the image signals at  $f_{RF}$ (low-high) and  $f_{RF}$ (low-low).

The two remaining signals at IF1 resulting from  $f_{RF}(high-high)$  and  $f_{RF}(high-low)$  are entering the second mixer MIX2. This mixer features image rejection with so-called single-sideband (SSB) selection. This means either the upper or lower sideband of IF1 can be selected. In the example of Fig. 2, LO2 high-side injection has been chosen to select the IF2 signal resulting from  $f_{RF}(high-high)$ .

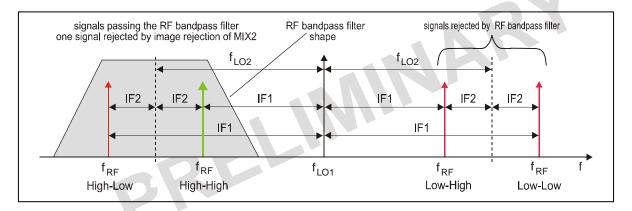


Fig. 2: The four receiving frequencies in a double conversion superhet receiver

It can be seen from the block diagram of Fig. 1 that there is a fixed relationship between the LO1 signal frequency  $f_{LO2}$  and the LO2 signal frequency  $f_{LO2}$ .

$$LO2DIV = N_{LO2} = \frac{f_{LO1}}{f_{LO2}}$$
 (1)

The LO1 signal frequency  $f_{LO1}$  is directly synthesized from the crystal reference oscillator frequency  $f_{RO}$  by means of an integer-N PLL synthesizer. The PLL consists of a dual-modulus prescaler (P/P+1), a program counter N and a swallow counter A.

$$f_{\text{LO1}} = \frac{f_{\text{RO}}}{R} (N \cdot P + A) = f_{\text{PFD}} (N \cdot P + A) = f_{\text{PFD}} \cdot N_{\text{tot}}$$
 (2)

### 300 to 930MHz Receiver Evaluation Board Description

Due to the double superhet receiver architecture, the channel frequency step size  $f_{CH}$  is not equal to the phase-frequency detector (PFD) frequency  $f_{PFD}$ . For high-side injection, the channel step size  $f_{CH}$  is given by:

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} - 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} - 1}{N_{LO2}}$$
(3)

While the following equation is valid for low-side injection:

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} + 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} + 1}{N_{LO2}}$$
(4)

#### 2.2 Calculation of Counter Settings

Frequency planning and the selection of the MLX71122's PLL counter settings are straightforward and can be laid out on the following procedure.

Usually the receive frequency  $f_{RF}$  and the channel step size  $f_{CH}$  are given by system requirements. The N and A counter settings can be derived from  $N_{tot}$  or  $f_{LO1}$  and  $f_{PFD}$  by using the following equations.

$$N = floor(\frac{N_{tot}}{P}) = floor(\frac{N_{tot}}{32}); A = N_{tot} - N \cdot P = N_{tot} - N \cdot 32$$
 (5)

#### 2.2.1 Calculation of LO1 and IF1 frequency for Low Frequency Bands

High-high injection must be used for the low frequency bands. First of all choose a PFD frequency  $f_{PFD}$  according to below table. The R counter values are valid for a 10MHz crystal reference frequency  $f_{RO}$ . The PFD frequency is given by  $f_{PFD} = f_{RO} / R$ .

Injection Type	f <sub>CH</sub> [kHz]	f <sub>PFD</sub> [kHz]	R
h-h	10	13.3	750
h-h	12.5	16.7	600
h-h	20	26.7	375
h-h	25	33.3	300
h-h	50	66.7	150
h-h	100	133.3	75
h-h	250	333.3	30

The second step is to calculate the missing parameters  $f_{LO1}$ ,  $f_{IF1}$ ,  $N_{tot}$ , N and A. While the second IF ( $f_{IF2}$ ), the  $N_{LO2}$  divider ratio and the prescaler divider ratio P are bound to  $f_{IF2} = 2MHz$ ,  $N_{LO2} = 4$  (or 8) and P =32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} - 1} (f_{RF} - f_{IF2}) \qquad f_{LO1} = \frac{4}{3} (f_{RF} - 2MHz)$$
 (6)

$$f_{IFI} = \frac{f_{RF} - N_{LO2} f_{IF2}}{N_{LO2} - 1} \qquad f_{IFI} = \frac{f_{RF} - 8MHz}{3}$$
 (7)

Finally N and A can be calculated with formula (5).

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#### 2.2.2 Calculation of LO1 and IF1 frequency for High Frequency Bands

Typical ISM band operating frequencies like 868.3 and 915MHz can be covered without changing the crystal nor the VCO inductor.

Low-low injection should be used for the high frequency bands. First of all choose a PFD frequency f<sub>PFD</sub> according to below table. The R counter values are valid for a 10MHz crystal reference. The PFD frequency is given by  $f_{PFD} = f_{RO} / R$ .

Injection Type	f <sub>CH</sub> [kHz]	f <sub>PFD</sub> [kHz]	R		
I-I	20	16	625		
I-I	25	20	500 250		
I-I	50	40			
I-I	100	80	125		
I-I	I-I 250		50		
I-I	500	400	25		

The second step is to calculate the missing parameters  $f_{LO1}$ ,  $f_{IF1}$ ,  $N_{tot}$ , N and A. While the second IF  $(f_{IF2})$ , the  $N_{LO2}$  divider ratio and the prescaler divider ratio P are bound to  $f_{IF2} = 2MHz$ ,  $N_{LO2} = 4$  (or 8) and P = 32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} + 1} (f_{RF} - f_{IF2}) \qquad f_{LO1} = \frac{4}{5} (f_{RF} - 2MHz)$$
 (8)

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} + 1} (f_{RF} - f_{IF2}) \qquad f_{LO1} = \frac{4}{5} (f_{RF} - 2MHz)$$

$$f_{IF1} = \frac{f_{RF} + N_{LO2} f_{IF2}}{N_{LO2} + 1} \qquad f_{IF1} = \frac{f_{RF} + 8MHz}{5}$$
(9)

Finally N and A can be calculated with formula (5).

#### 2.2.3 Counter Setting Examples for SPI Mode

To provide some examples, the following table shows some counter settings for the reception of the wellknown ISM and SRD frequency bands. The channel spacing is assumed to be f<sub>CH</sub> = 100kHz. In below table all frequency units are in MHz.

lnj	f <sub>RF</sub>	f <sub>IF1</sub>	f <sub>LO1</sub>	N <sub>tot</sub>	N	Р	Α	f <sub>PFD</sub>	R	f <sub>REF</sub>	f <sub>LO2</sub>	f <sub>IF2</sub>
h-h	300	97.3	397.3	2980	93	32	4	0.133	75	10	99.3	2
h-h	315	102.3	417.3	3130	97	32	26	0.133	75	10	104.3	2
h-h	434	142	576	4320	135	32	0	0.133	75	10	144	2
h-h	470	154	624	4680	146	32	8	0.133	75	10	156	2
I-I	850	171.6	678.4	8480	256	32	0	0.08	125	10	169.6	2
I-I	868	175.2	692.8	8660	270	32	20	0.08	125	10	173.2	2
I-I	915	184.6	730.4	9130	285	32	10	0.08	125	10	182.6	2
I-I	930	187.6	742.4	9280	290	32	0	0.08	125	10	185.6	2

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### 2.2.4 Counter Settings in ABC Mode – 8 Preconfigured Channels

In ABC mode (SPISEL=0), the counter settings are hard-wired. In below table all frequency units are in MHz.

FSK	f <sub>RF</sub>	f <sub>IF1</sub>	f <sub>LO1</sub>	N <sub>tot</sub>	N	Р	Α	f <sub>PFD</sub>	R	f <sub>REF</sub>	f <sub>LO2</sub>	f <sub>IF2</sub>
1	369.5	120.5	490.0	3675	114	32	27	0.133	75	10	122.5	2
2	371.1	121.0	492.0	3691	115	32	11	0.133	75	10	123.0	2
3	375.3	122.4	497.7	3733	116	32	21	0.133	75	10	124.4	2
4	376.9	123.0	499.9	3749	117	32	5	0.133	75	10	125.0	2
5	388.3	126.8	515.1	3863	120	32	23	0.133	75	10	128.8	2
6	391.5	127.8	519.3	3895	121	32	23	0.133	75	10	129.8	2
7	394.3	128.8	523.1	3923	122	32	19	0.133	75	10	130.8	2
8	395.9	129.3	525.2	3939	123	32	3	0.133	75	10	131.3	2

	List of Mathematical Acronyms
A	divider ratio of the swallow counter (part of feedback divider)
$f_{FB}$	frequency at the feedback divider output
floor(x)	The floor function gives the largest integer less than or equal to x. For example, floor(5.4) gives 5, floor(-6.3) gives -7.
$f_{PFD}$	PFD frequency in locked state
$\frac{f_{RO}}{R} = f_R$	reference frequency of the PLL
$f_{RO}$	frequency of the crystal reference oscillator
$f_{VCO}$	frequency of the VCO (equals the LO1 signal of the first mixer)
$N_{tot} = N \cdot P + A$	total divider ratio of the PLL feedback path
N	divider ratio of the program counter (part of feedback divider)
N <sub>LO2</sub>	LO2DIV divider ratio, to derive the LO2 signal from LO1 ( $N_1 = 4$ or 8)
P	divider ratio of the prescaler (part of feedback divider)
R	divider ratio of the reference divider R

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#### 2.2.5 PLL Counter Ranges

In order to cover the frequency range of about 300 to 930MHz the following counter values are implemented in the receiver:

	PLL Counter Ranges										
A N R P											
0 to 31 (5bit) 3 to 2047 (11bit) 3 to 2047 (11bit) 32											

Therefore the minimum and maximum divider ratios of the PLL feedback divider are given by:

$$N_{totmin} = 32 \cdot 32 = 1024$$
  $N_{totmax} = 2047 \cdot 32 + 31 = 65535$ 

#### 2.3 SPI Description

#### 2.3.1 General

Serial programming interface (SPI) mode can be activated by choosing SPISEL = 1 (e.g. at positive supply voltage  $V_{CC}$ ). In this mode, the input pins 17, 18 and 19 are used as a 3-wire unidirectional serial bus interface (SDEN, SDTA, SCLK). The internal latches contain all user programmable variables including counter settings, mode bits etc.

In addition the MFO pin can be programmed as an output (see section 4.1.4) in order to read data from the internal latches and it can be used as an output for different test modes as well.

At each rising edge of the SCLK signal, the logic value at the SDTA terminal is written into a shift register. The programming information is taken over into internal latches with the rising edge of SDEN. Additional leading bits are ignored, only the last bits are serially clocked into the shift register. A normal write operation shifts 16 bits into the SPI, a normal read operation shifts 4 bits into the SPI and reads additional 12 bits from the MFO pin. If less than 12 data bits are shifted into SDTA during the write operation then the control register may contain invalid information.

In general a control word has the following format. Bit 0 is the Read/Write bit that determines whether it is a read (R/W = 1) or a write (R/W = 0) sequence. The R/W bit is preceding the latch address and the corresponding data bits.

Control Word Format															
MSB											LSB	MSB		LSB	Bit 0
	Data										Latc	h Add	ress	Mode	
D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	A2	A2	A0	R/W

There are two control word formats for read and for write operation. Data bits are only needed in write mode. Read operations require only a latch address and a R/W bit.

Due to the static CMOS design, the serial interface consumes virtually no current. The SPI is a fully separate building block and can therefore be programmed in every operational mode.

#### 2.3.2 Read / Write Sequences

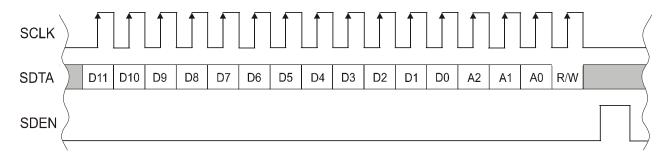


Fig. 6 Typical write sequence diagram

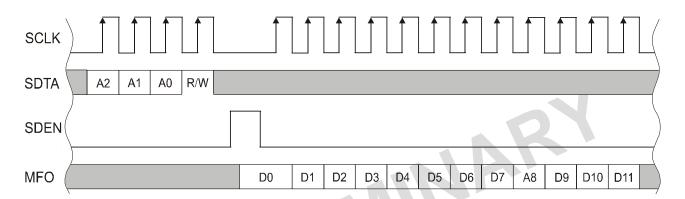


Fig. 7 Typical read sequence diagram

#### 2.3.3 Serial Programming Interface Timing

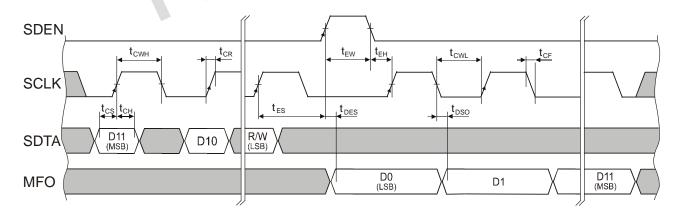


Fig. 8 SPI timing diagram



### 3 Register Description

The following tables are to describe the functionality of the registers.

Sec. 4.1 provides a register overview with all the control words R0 to R7. The subsequent sections. 4.1.1 to 4.1.8 show the content of the control words in more detail.

Programming the registers requires SPI mode (SPISEL = 1). Default settings are for ABC mode.

#### 3.1 Register Overview

CONTROL WORD	MSB					DA	TA					LSB		ATCI DRE	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	0	1	1	1	0	0	0	1	0	0	0	0	0	0
R0	DTAPOL	SLCSEL	SSBSEL	DEMGAIN	IFFGAIN	[1:0]	MIX2GAIN	MIX1GAIN	LNAGAIN	[1:0]	OPMODE	[1:0]		read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	0	0	0	1	0	1	1	0	1	0	0	0	0	1
R1	SHOWLD	PRESCUR	VCOBUF	VCOCUR	VCORANGE	ГРМОРЕ	LDTIME	[ 1 :0 ]	LDERR	PFDPOL	CPCUR	[1:0]		read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	1	1	0	1	1	1	0	1	1	0	0	0	1	0
R2				N [6:0]						A [4:0]				read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	1	0	0	0	0	0	0	0	0	0	0	0	1	1
R3		MFO	[3:0]		AGCDEL	[1:0]	AGCEN	LO2DIV		z	[10:7]			read/ write	

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CONTROL WORD						DA	TA							ATCI DRE	
WORD	MSB											LSB	AL	DKE	၁၁
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	0	0	0	1	0	0	1	0	1	1	1	0	0
R4	AGCMODE						R [10:0]							read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	1	0	1	0	0	1	1	0	1	1	1	0	1
R5	MODSEL						RIFF [10:0]							read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	0	1	0	0	1	1	0	1	1	0	0	1	1	0
R6	ROCUR	[1:0]	IFFTUNE	IFFHLT				IFFPRES	[7:0]					read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default					4			1					1	1	1
R7	RSSIH	LDRSSIL*	IFFSTATE	[1:0]				IFFVAL	[7:0]					read- only	

Note: \* depends on bit 11 in R4, 0 = RSSIL, 1 = LD



# 300 to 930MHz Receiver Evaluation Board Description

#### 3.1.1 Control Word R0

Name	Bits			Description					
				operation mode					
OPMODE	[1:0]	00 01 10 11	shutdown receive mode reference oscillato synthesizer only	or & BIAS only	#default				
				LNA gain					
LNAGAIN	[3:2]	00 01 10 11	lowest gain low gain high gain highest gain	(-18dB) (-4dB) (0dB) (+2dB)	#default				
			gain values are relative t						
MIX1GAIN	[4]		1	1 <sup>st</sup> Mixer gain	<i>,</i> , , , , , , , , , , , , , , , , , , ,				
WIIATGAIN	[4]	0 1	high gain low gain	(14dB) (0dB)	#default				
				2 <sup>nd</sup> Mixer gain					
MIX2GAIN	[5]	0 1	high gain low gain	(9dB) (-2dB)	#default				
			intermediate frequency filter gain						
IFFGAIN	[7:6]	00 01 10 11	lowest gain low gain high gain highest gain	(-14dB) (-6dB) (0dB) (+6dB)	#default				
				demodulator gain					
DEMGAIN	[8]	0 1	low gain high gain	(~ 4mV/kHz) (~ 15mV/kHz)	#default				
				single side band selection					
SSBSEL	[9]	0 1	upper side band lower side band	LO2 low-side inj. (IF1 = LO2 + IF2) LO2 high-side inj. (IF1 = LO2 - IF2)	#default				
			Internal IF2 = 2MHz						
SI CSEI	[0]			slicer mode select	<i>,,</i> 1, 6, 1,				
SLCSEL	[9]	0 1	averaging Data Sli peak detector Data		#default				
				data output polarity OA2					
		0	inverted						
DTAPOL	[11]		<sub>min</sub> at FSK, '0' for mark at ASK or f <sub>max</sub> at FSK						
		1	normal		#default				
			'0' for space at ASK or f <sub>m</sub>	<sub>min</sub> at FSK, '1' for mark at ASK or f <sub>max</sub> at FSK					



### 300 to 930MHz Receiver Evaluation Board Description

#### 3.1.2 Control Word R1

Name	Bits	Description	
		charge pump current setting	
CPCUR	[1:0]	00   100μA 01   400μA 10   400μA static down 11   400μA static up	#default
		PFD output polarity	
PFDPOL	[2]	0 negative 1 positive	#default
	ro1	lock detector time error	
LDERR	[3]	0 15ns 1 30ns	#default
		lock detection time	
LDTIME	[5:4]	00	#default
		$f_R$ is the reference oscillator frequency $f_{RO}$ divided by R, see section 4.1.5	(R4)
LDMODE	[6]	0 check lock condition permanently 1 check lock condition until 1 <sup>st</sup> lock in	#default
		VCO range	
VCORANGE	[7]	0 3V supply 1 5V supply	#default
		VCO range setting for different VCCs.	
VCOCUR	[8]	VCO core current	// -l - <b>f</b> lt
VCOCOR	[o]	0 450μA 1 520μA	#default
		VCO buffer current	
VCOBUF	[9]	0 900μA 1 1040μA	#default
		prescaler 32/33 reference current	
PRESCUR	[10]	0 20μA 1 30μA	#default
		$30\mu\text{A}$ may be used for $f_{RF} = 868/915\text{MHz}$	
		function of LDRSSIL bit	
SHOWLD	[11]	0 RSSIL (RSSI low flag) 1 LD (lock detection flag)	#default
		select output data of LDRSSIL, see section 4.1.8 (R7)	

### 300 to 930MHz Receiver Evaluation Board Description

#### 3.1.3 Control Word R2

Name	Bits		Description	
			swallow counter value	
Α	[4:0]	01100	value is 12	#default
			swallow counter range: 0 to 31	
			program counter value (bits 0 - 6)	
N	[11:5]	000 0111 0111	N value is 119	#default
			N counter range: 3 to 2047	

#### 3.1.4 Control Word R3

				program counter range (bits 7 – 10)				
N	[3:0]	000 01	111 0111	N value is 119	#default			
				N counter range: 3 to 2047				
				LO2 divider ratio	d			
LO2DIV	[4]	0 1	divide b		#default			
				AGC enable mode				
AGCEN	[5]	0 1	disabled enabled		#default			
			AGC delay settings					
AGCDEL	[7:6]	00 01 10 11	no delay 3/f <sub>IFF</sub> 15/f <sub>IFF</sub> 31/f <sub>IFF</sub>	<b>y</b>	#default			
			f <sub>IFF</sub> is the r	reference oscillator frequency $f_{RO}$ divided by RIFF, see section 4.	1.6 (R6)			
				multi functional output				
MFO	[11:8]	0000 0001 0010 0011 0100 0101 1000	MFO is a MFO is a MFO is a MFO is a		#default			



#### 3.1.5 Control Word R4

Name	Bits		Description						
				reference divider range					
R	[10:0]	000 01	100 1011	value is 75	#default				
				R counter range: 3 to 2047					
				AGC delay mode					
AGCMODE	[11]	0	<ul> <li>gain decrease and increase with delay</li> <li>gain decrease without delay, gain increase with delay</li> </ul>						
		selects AGC delay mode in combination with AGCDEL bits, see section							

#### 3.1.6 Control Word R5

Name	Bits		Description							
				reference divider value for IFF adjustment						
RIFF	[10:0]	010 1001 1011		value is 667	#default					
				IFF counter range: 4 to 2047						
				demodulation selection						
MODSEL	[11]	0 1		nodulation nodulation	#default					
			selects modulation type when chip is controlled via SPI mode							

#### 3.1.7 Control Word R6

Name	Bits	Description					
IFFPRES	[7:0]	0110 1100		value is 108	#default		
				IFF DAC preset at start of automatic tuning			
				IFF halt			
IFFHLT	[8]	0 1					
	[9]			IFF tuning			
IFFTUNE		0 1	disable enable	and load DAC with IFFPRES	#default		
				reference Oscillator core current			
ROCUR	[11:10]	00 01 10 11	85μΑ 170μΑ 270μΑ 355μΑ		#default		



### 300 to 930MHz Receiver Evaluation Board Description

#### 3.1.8 Control Word R7 (Read-only Register)

Name	Bits	Description					
		IFF adjustment value					
IFFVAL	[7:0]						
		see also IFFPRES in section 4.1.7 (R6)					
		IFF automatic tuning state					
IFFSTATE	[9:8]	<ul> <li>filter tuned or auto-tuning disabled</li> <li>tuning up the filter frequency</li> <li>tuning down the filter frequency</li> <li>master oscillator of filter deactivated</li> </ul>					
		lock detector or RSSI low flag					
LDRSSIL	[10]	0 PLL not locked or RSSI value in lower region 1 PLL locked or RSSI value above lower region					
		depends on SHOWLD in section 4.1.2 (R1)					
	[11]	RSSI high flag					
RSSIH		0 RSSI value below upper region 1 RSSI value in upper region					
	P						

### 4 Application Circuits

#### 4.1 Standard FSK & ASK Circuit in SPI Mode

#### 4.1.1 Averaging Data Slicer Configured for Bi-Phase Codes

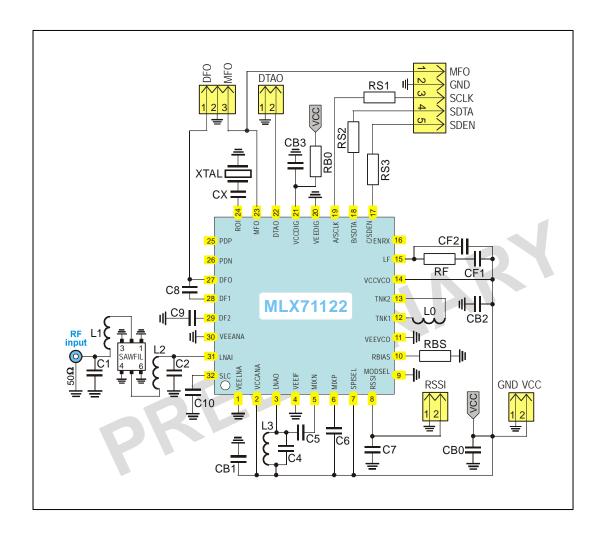


Fig. 6: Application circuit for SPI Mode (averaging data slicer option)

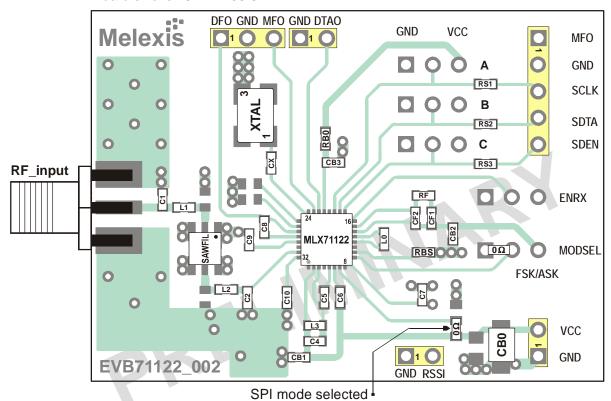
#### Note

EVB71122 default population is SPI mode



#### 4.1.2 Component Arrangement Top Side for SPI Mode (Averaging Data Slicer)

#### Board size is 49mm x 35.6mm





#### 4.1.3 Peak Detector Data Slicer Configured for NRZ Codes

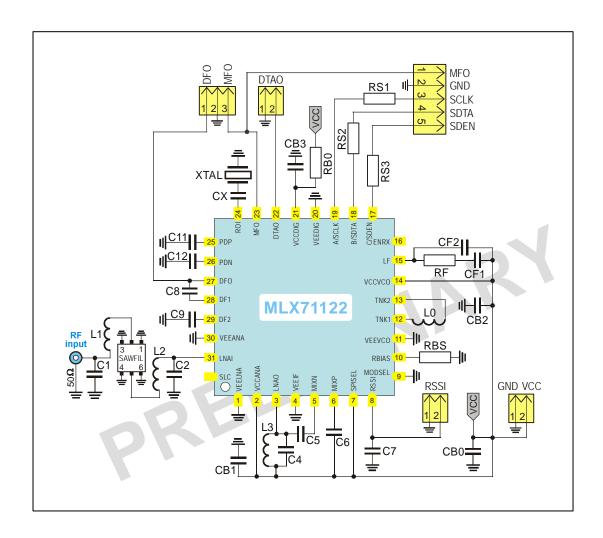


Fig. 7: Application circuit for SPI Mode (peak detector option)

#### Note

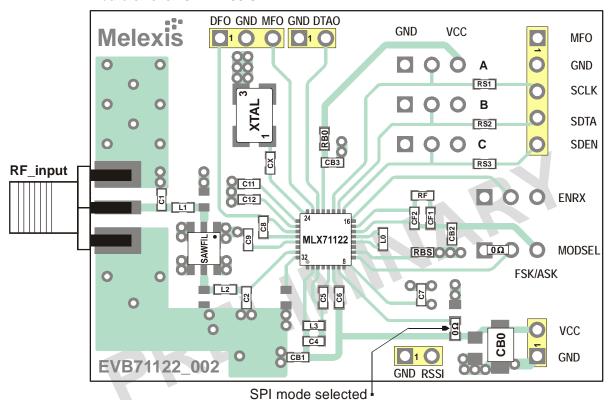
• EVB71122 default population is SPI mode



# **Evaluation Board Description**

#### 4.1.4 Component Arrangement Top Side for SPI Mode (Peak Detector Data Slicer)

#### Board size is 49mm x 35.6mm



### 300 to 930MHz Receiver Evaluation Board Description

#### 4.1.5 Board Component Values List (SPI mode)

Below table is for all application circuits show in Figures 6 and 7

Part	Size	Value @ 315 MHz	Value @ Value @ 433.9 MHz 868.3 M		Value @ 915 MHz	Tol.	Description		
C1	0603	NIP	NIP	3.3 pF	NIP	±5%	matching capacitor		
C2	0603	NIP	NIP	NIP	NIP	±5%	matching capacitor		
C4	0603	4.7 pF	3.3 pF	2.7 pF	2.2 pF	±5%	LNA output tank capacitor		
C5	0603	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 negative input matching capacitor		
C6	0603	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 negative input matching capacitor		
C7	0603	1 nF	1 nF	1 nF	1 nF	±10%	RSSI output low pass capacitor, this value for data rates 4 kbps NRZ		
C8	0603	330 pF	330 pF	330 pF	330 pF	±10%	data low-pass filter capacitor, this value for data rates 4 kbps NRZ		
C9	0603	150 pF	150 pF	150 pF	150 pF	±10%	data low-pass filter capacitor, this value for data rates 4 kbps NRZ		
C10	0603	33 nF	33 nF not required	33 nF In Figure 7	33 nF	±10%	data slicer capacitor		
C11	0603	33 nF	33 nF	33 nF	33 nF	±10%	peak detector positive filtering		
CII	0603		not required	in Figures 6	capacitor				
C12	0603	33 nF	33 nF 33 nF 33 nF ±10%				peak detector negative filtering capacitor		
CB0	1210	10 μF	10 μF 10 μF		10 μF	±10%	decoupling capacitor, low-noise power supply recom- mended		
CB1	0603	470 pF	470 pF	470 pF	470 pF	±10%	decoupling capacitor		
CB2	0603	33 nF	33 nF	33 nF	33 nF	±10%	decoupling capacitor		
CB3	0603	33 nF	33 nF	33 nF	33 nF	±10%	decoupling capacitor		
CF1	0603	2.2 nF	2.2 nF	2.2 nF	2.2 nF	±5%	loop filter capacitor		
CF2	0603	220 pF	220 pF	220 pF	220 pF	±5%	loop filter capacitor		
CX	0603	27 pF	27 pF	27 pF	27 pF	±5%	crystal series capacitor		
RB0	0603	10 Ω	10 Ω	10 Ω	10 Ω	±5%	protection resistor		
RF	0603	27 kΩ	27 kΩ	47 kΩ	47 kΩ	±5%	loop filter resistor		
RBS	0603	30 kΩ	30 kΩ	30 kΩ	30 kΩ	±2%	reference bias resistor		
RS1RS3		10 kΩ	10 kΩ	10 kΩ	10 kΩ	±5%	protection resistor		
L0	0603	33 nH	15 nH	8.2 nH	8.2 nH	±5%	VCO tank inductor		
L1	0603	0 Ω	56 nH	22 nH	0 Ω	±5%	matching inductor		
L2	0603	82 nH	82 nH	22 nH	8.2 nH	±5%	matching inductor		
L3	0603	33 nH	22 nH	5.6 nH	5.6 nH	±5%	LNA output tank inductor		
XTAL	SMD 5x3.2	1	0.00000 MHz / ±2	fundamental-mode crystal					
SAW FIL	SMD 3x3	SAFDC315MS M0T00 (315 MHz)	SAFCC433MB L0X00 (433.92 MHz)	SAFCC868MS L0X00 (868.3 MHz)	SAFCH915MA L0N00 (915 MHz)		low-loss SAW filter from Murata or equivalent part		

**Note:** - NIP – not in place, may be used optionally

#### 4.2 Standard FSK & ASK circuit in 8-Channel Preconfigured (ABC) Mode

#### 4.2.1 Averaging Data Slicer Configured for Bi-Phase Codes

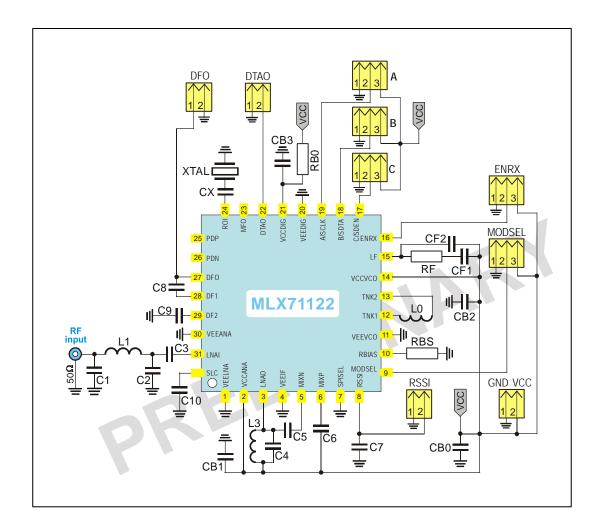


Fig. 8: Application circuit for ABC Mode

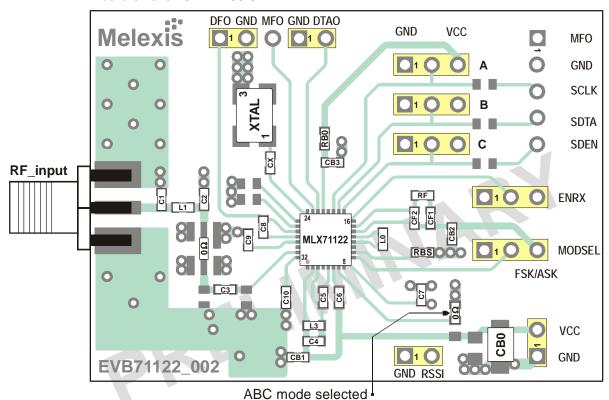
#### Note

 ABC mode population can be easily modified from default SPI mode population by changing the connection at SPISEL from VCC to ground.



#### 4.2.2 Component Arrangement Top Side for ABC Mode (averaging data slicer)

#### Board size is 49mm x 35.6mm



### 300 to 930MHz Receiver Evaluation Board Description

#### 4.2.3 Board Component Values List (ABC mode)

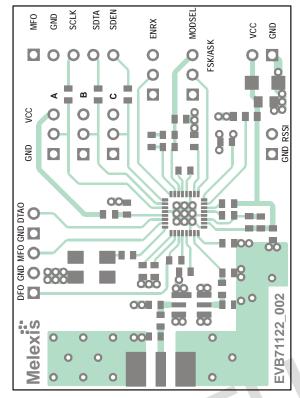
Below table is for all application circuits show in Figures 8

Part	Size	Value @ 369 MHz to 396 MHz	Tol.	Description			
C1	0603	NIP	±5%	matching capacitor			
C2	0603	NIP	±5%	matching capacitor			
C3	0603	100 pF	±5%	LNA input filtering capacitor			
C4	0603	3.3 pF	±5%	LNA output tank capacitor			
C5	0603	100 pF	±5%	MIX1 negative input matching capacitor			
C6	0603	100 pF	±5%	MIX1 negative input matching capacitor			
C7	0603	1 nF	±10%	RSSI output low pass capacitor, this value for data rates 4 kbps NRZ			
C8	0603	330 pF	±10%	data low-pass filter capacitor, this value for data rates 4 kbps NRZ			
C9	0603	150 pF	±10%	data low-pass filter capacitor, this value for data rates 4 kbps NRZ			
C10	0603	33 nF	±10%	data slicer capacitor			
CB0	1210	10 μF	±10%	decoupling capacitor, low-noise power supply recommended			
CB1	0603	470 pF	±10%	decoupling capacitor			
CB2	0603	33 nF	±10%	decoupling capacitor			
CB3	0603	33 nF	±10%	decoupling capacitor			
CF1	0603	2.2 nF	±5%	loop filter capacitor			
CF2	0603	220 pF	±5%	loop filter capacitor			
CX	0603	27 pF	±5%	crystal series capacitor			
RB0	0603	10 Ω	±5%	protection resistor			
RF	0603	27 kΩ	±5%	loop filter resistor			
RBS	0603	30 kΩ	±2%	reference bias resistor			
RS1RS3	0603	10 kΩ	±5%	protection resistor			
L0	0603	18 nH	±5%	VCO tank inductor			
L1	0603	39 nH	±5%	matching inductor			
L3	0603	27 nH	±5%	LNA output tank inductor			
XTAL	SMD 5x3.2	10.00000 MHz / ±20ppm cal., ±30ppm	m temp.	fundamental-mode crystal			

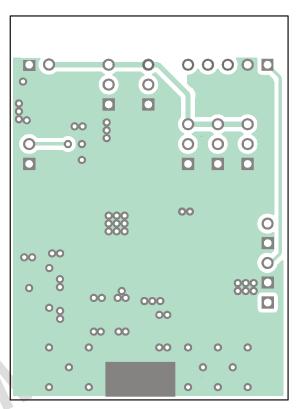
**Note:** - NIP – not in place, may be used optionally

### 5 Evaluation Board Layouts

• Board layout data in Gerber format is available, board size is 35.6mm x 49mm.







PCB bottom view

#### 6 Board Variants

Туре	Regional Code		Frequency/MHz		Modulation		Board Execution		
EVB71122	С	world wide	-315		-FSK		-A	antenna version	
	Α	Europe, Asia	-433		-ASK		-C	connector version	
	<b>B</b> USA, Canada		-868		-FM				
			-915						

Note: possible combinations



### 7 Package Description

The device MLX71122 is RoHS compliant.

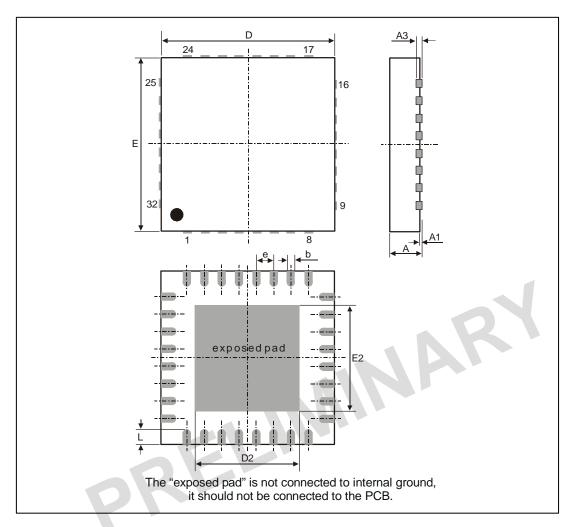


Fig 12: 32L QFN 5x5 Quad

all Dime	all Dimension in mm											
	D	Е	D2	E2	Α	A1	А3	L	е	b		
min	4.75	4.75	3.00	3.00	0.80	0	0.20	0.3	0.50	0.18		
max	5.25	5.25	3.25	3.25	1.00	0.05	0.20	0.5	0.50	0.30		
all Dime	all Dimension in inch											
min	0.187	0.187	0.118	0.118	0.0315	0	0.0079	0.0118	0.0197	0.0071		
max	0.207	0.207	0.128	0.128	0.0393	0.002	0.0079	0.0197	0.0197	0.0118		

#### 7.1 Soldering Information

 The device MLX71122 is qualified for MSL3 with soldering peak temperature 260 deg C according to JEDEC J-STD-20



### 300 to 930MHz Receiver Evaluation Board Description

#### 8 Reliability Information

This Melexis device is classified and qualified regarding soldering technology, solderability and moisture sensitivity level, as defined in this specification, according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

IPC/JEDEC J-STD-020

"Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)"

EIA/JEDEC JESD22-A113

"Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)"

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

EN60749-20

"Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat" EIA/JEDEC JESD22-B106 and EN60749-15

"Resistance to soldering temperature for through-hole mounted devices"

Iron Soldering THD's (Through Hole Devices)

EN60749-15

"Resistance to soldering temperature for through-hole mounted devices"

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

EIA/JEDEC JESD22-B102 and EN60749-21 "Solderability"

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualification of **RoHS** compliant products (RoHS = European directive on the Restriction Of the Use of Certain Hazardous Substances) please visit the quality page on our website:

http://www.melexis.com/quality\_leadfree.aspx

#### 9 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.



300 to 930MHz Receiver Evaluation Board Description

**Your Notes** 





### 300 to 930MHz Receiver Evaluation Board Description

#### 10 Disclaimer

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